EFS-Web Receipt date: 01/10/2007

Docket No.: UNIU79.064APC

10565565 - GAU: 4171

Customer No. 20,995

INFORMATION DISCLOSURE STATEMENT

Applicant

Tomohide BANBA et al.

App. No

10/565,565

Filed

January 23, 2006

For

AN INORGANIC POWDER-CONTAINING

RESIN COMPOSITION, A FILM-FORMING MATERIAL LAYER, A TRANSFER SHEET, METHOD OF PRODUCING A SUBSTRATE HAVING A DIELECTRIC LAYER FORMED THEREON, AND A SUBSTRATE HAVING A DIELECTRIC LAYER FORMED THEREON

Examiner

SZEKELY, Peter A.

Art Unit

1714

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing 9 references to be considered by the Examiner. Also enclosed are 9 foreign patent references and/or non-patent literature as listed on the Information Disclosure Statement.

This Information Disclosure Statement is being filed before the mailing date of a final action and before the mailing date of a Notice of Allowance.

CERTIFICATION UNDER 37 C.F.R. § 1.97(e)(1)

I hereby certify that each item of information contained in this Statement was first cited in a communication from a foreign Patent Office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

Thus, no fee is required as set forth in 37 C.F.R. § 1.97(c).

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 10-Jan-07

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PTO/SB/08 Equivalent Application No. 10/565,565 INFORMATION DISCLOSURE Filing Date January 23, 2006 First Named Inventor Tomohide BANBA STATEMENT BY APPLICANT Art Unit 1714 (Multiple sheets used when necessary) Examiner SZEKELY, Peter A. SHEET 1 OF 1 Attorney Docket No. UNIU79.064APC

| | U.S. PATENT DOCUMENTS | | | | | | | | | |
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| Examiner Initials | Cite No. | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T ¹ | | | |
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Examiner Signature

/John Uselding/

Date Considered

04/01/2008

*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.